Copper - ETP

Busbars



Material Designation		
	044000	
ASTM	C11000	
JIS	C1100	
INDIAN	Cu-ETP	
EN	CW004A	
BS	C101	

Chemical Composition (%)				
Cu	99.90 (Min.)			
02	0.04 (Max.)			

Applications		
Transformers		
Switchgears		
Control Panels		
Components		

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Thickness 2 - 20 mmWidth 10 - 250 mmLength 3000 - 5000 mm

Temper O, 1/4H, 1/2H, 3/4H, H, EH, SH

Edges

Square Corners Round Corners Full Round edges Semi Round Edges

Description

Electrolytic-Tough-Pitch (ETP) is the most common copper with a minimum conductivity rating of 99.99% IACS and is required to be 99.9% pure. It has 0.02% to 0.04% oxygen content within 20 ppm. It has clean bright surface. Busbars are used within electrical installation for distributing power from a supply point to a number of output circuits.

Value Proposition

- Competitive Pricing
- Flexible LME price fixation
- Product Customization

- Quality Assurance
- Committed to deliveries
- Standard export pallet packing

This data is general technical specification; Binding technical specifications will be as per agreement.